

Data Sheet November 2013

15 A, 600 V, Ultrafast Diode

The RUR1S1560S is an ultrafast diode with low forward voltage drop. This device is intended for use as freewheeling and clamping diodes in a variety of switching power supplies and other power switching applications. It is specially suited for use in switching power supplies and industrial application.

Ordering Information

PART NUMBER	PACKAGE	BRAND
RUR1S1560S	TO-263-3L	RUR1560

NOTE: When ordering, use the entire part number. Add the suffix 9A to obtain the TO-263 variant in tape and reel, i.e. RUR1S1560S9A.

Symbol



Features

- Ultrafast Recovery t_{rr} = 60 ns (@ I_F = 15 A)
- Max Forward Voltage, V_F = 1.5 V (@ T_C = 25°C)
- 600 V Reverse Voltage and High Reliability
- Avalanche Energy Rated
- RoHS Compliant

Applications

- · Switching Power Supplies
- · Power Switching Circuits
- General Purpose

Packaging JEDEC TO-263



Absolute Maximum Ratings T_C = 25°C, Unless Otherwise Specified

SYMBOL	PARAMETER	RUR1S1560S	UNIT	
V_{RRM}	Peak Repetitive Reverse Voltage	600	V	
V _{RWM}	Working Peak Reverse Voltage	600	V	
V _R	DC Blocking Voltage	600	V	
I _{F(AV)}	Average Rectified Forward Current	15	Α	
I _{FRM}	Repetitive Peak Surge Current (20 kHz Square Wave)	30	Α	
I _{FSM}	Nonrepetitive Peak Surge Current (Halfwave 1 Phase 60 Hz)	200	Α	
P _D	Power Dissipation	100	W	
E _{AVL}	Avalanche Energy (1 A, 40 mH)	20	mJ	
T _J , T _{STG}	Operating and Storage Temperature	-55 to 175	οС	
TL	Maximum Temperature for Soldering	300	οС	
T _{pkg}	Leads at 0.063 in (1.6 mm) from Case for 10 s	260	οС	
Ping	Package Body for 10s, See Techbrief TB334			
ERMAL SPECIFIC	CATIONS	1		
$R_{ heta JC}$	Thermal Resistance Junction to Case	1.5	°C/W	
$R_{\theta JA}$	Thermal Resistance Junction to Ambient	60	oC/W	

NOTES:

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

Electrical Specifications T_C = 25°C, Unless Otherwise Specified

SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
V _F	I _F = 15 A		-	1.5	V
	I _F = 15 A, T _C = 150°C		-	1.2	V
I _R	V _R = 600 V	-	-	100	μΑ
	$V_R = 600 \text{ V}, T_C = 150^{\circ}\text{C}$	-	-	500	μΑ
t _{rr}	I _F = 1 A, dI _F /dt = 100 A/μs, V _R = 30 V	-	-	55	ns
	$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	-	-	60	ns
t _a	I _F = 1 A, dI _F /dt = 100 A/μs, V _R = 30 V	-	20	-	ns
	$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	-	30	-	ns
t _b	I _F = 1 A, dI _F /dt = 100 A/μs, V _R = 30 V	-	15	-	ns
	$I_F = 15 \text{ A}, dI_F/dt = 100 \text{ A/}\mu\text{s}, V_R = 30 \text{ V}$	-	17	-	ns

DEFINITIONS

 V_F = Instantaneous forward voltage (pw = 300 μ s, D = 2%).

 I_R = Instantaneous reverse current.

 T_{rr} = Reverse recovery time (See Figure 9), summation of t_a + t_b .

 t_a = Time to reach peak reverse current (See Figure 9).

 t_b = Time from peak I_{RM} to projected zero crossing of I_{RM} based on a straight line from peak I_{RM} through 25% of I_{RM} (See Figure 9).

pw = pulse width.

D = duty cycle.

Typical Performance Curves

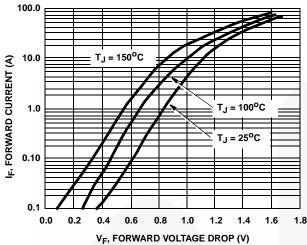


FIGURE 1. FORWARD VOLTAGE vs FORWARD CURRENT CHARACTERISTIC

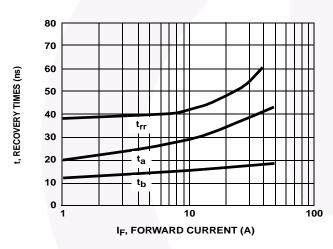


FIGURE 3. 5. TYPICAL t_{RR} , t_{A} AND t_{B} CURVES vs FORWARD CURRENT

200 100 T_J = 150⁰C 10 IR, REVERSE CURRENT (µA) $T_{\rm J} = 100^{\rm O}{\rm C}$ 0.1 0.010 $T_{\rm J} = 25^{\rm o}{\rm C}$ 0.001 100 200 300 400 500 600 V_R, REVERSE VOLTAGE (V) FIGURE 2. REVERSE VOLTAGE vs REVERSE CURRENT

CHARACTERISTIC

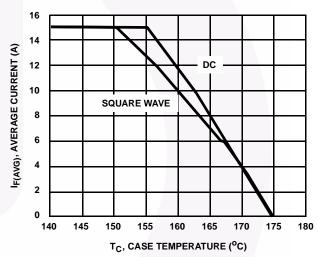


FIGURE 4. 6. TYPICAL CURRENT DERATING CURVE vs **CASE TEMPERATURE**

Test Circuits and Waveforms

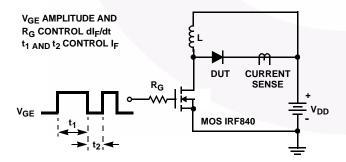


FIGURE 5. t_{rr} TEST CIRCUIT

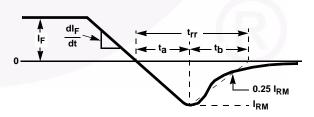


FIGURE 6. t_{rr} WAVEFORMS AND DEFINITIONS

Test Circuits and Waveforms (Continued)

I = 1A L = 40mH $R < 0.1\Omega$ $V_{DD} = 50V$ $E_{AVL} = 1/2LI^2 \left[V_{R(AVL)} / (V_{R(AVL)} - V_{DD}) \right]$ $Q_1 = IGBT \left(BV_{CES} > DUT \ V_{R(AVL)} \right)$ CURRENT + 0 $SENSE V_{DD}$ V_{DD} V_{DD}

FIGURE 7. AVALANCHE ENERGY TEST CIRCUIT

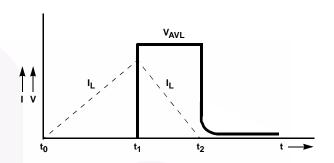


FIGURE 8. AVALANCHE CURRENT AND VOLTAGE WAVEFORMS

Mechanical Dimensions

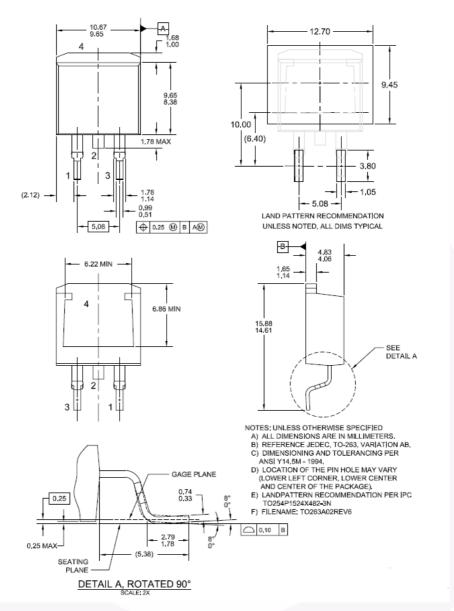


Figure 9. TO-263 2L (D2-PAK) - 2LD, TO263, SURFACE MOUNT

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